## **Errata**

1. Sensors and Materials Vol. 32, No. 12(3) (2020), pp. 4277–4297

Using Graphene-powder-based Thermal Interface Material for High Lumen LED Array Chip: An Experimental Study of Heat Dissipation

by Chih-Neng Hsu, Chun-Chih Chen, Chen-Hui Chang, and Cheng-Chi Wang

On page 4295, "MOST 108-2221-E-167-005-MY2" in line 3 of Acknowledgments should be "MOST 108-2221-E-167-013-MY2".